

**Description** 

The SECG1E07C-SD is a surface mount blue LED.

#### **Features**

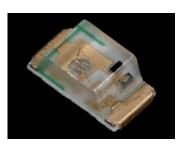
- Luminous Intensity,  $I_V$ ----- 50 mcd (typ.) ( $I_F = 10 \text{ mA}$ ) • Forward Voltage,  $V_F$ ------ 3.1 V (typ.) ( $I_F = 10 \text{ mA}$ ) • Dominant Wavelength,  $\lambda_D$  ----- 465.0 nm • Viewing Angle,  $2\theta_{1/2}$ ------150 deg
- MSL 3
- RoHS Compliant
- Pb-free, Reflow Soldering
- High Reliability

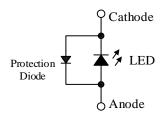
## **Applications**

- Automotive Interior
- Switch
- Indicator

## **Package**

Dimensions (L  $\times$  W  $\times$  H): 1.6  $\times$  0.8  $\times$  0.7 mm





Not to scale

### SECG1E07C-SD

### **Absolute Maximum Ratings**

Unless specifically noted,  $T_A = 25$  °C.

Parameter	Symbol	Conditions	Rating	Unit
Power Dissipation	P <sub>D</sub>		108	mW
Forward Current	$I_{\mathrm{F}}$		30	mA
Forward Current Reduction	$\Delta I_{\mathrm{F}}$	T <sub>A</sub> ≥ 43 °C	-0.52	mA/°C
Pulse Forward Current	$I_{FP}$	Frequency = 1 kHz Pulse Width ≤ 100 μs	50	mA
Reverse Current	$I_R$		10	mA
Operating Temperature	$T_{OP}$		-40 to 85	°C
Storage Temperature	$T_{STG}$		-40 to 100	°C
Junction Temperature	Тл		115	°C

## **Electrical / Optical Characteristics**

Unless specifically noted,  $T_A = 25$  °C.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	$V_{\mathrm{F}}$	$I_F = 10 \text{ mA}$	_	3.1	3.6	V
Reverse Voltage	$V_R$	$I_R = 1 \text{ mA}$	_	0.8	_	V
Luminous Intensity	$I_V$	$I_F = 10 \text{ mA}$	36	50	63	mcd
Dominant Wavelength	$\lambda_{\mathrm{D}}$	$I_F = 10 \text{ mA}$	462.5	465.0	470.0	nm
Viewing Angle	$2\theta_{1/2}$	$I_F = 10 \text{ mA}$		150		deg
Thermal Resistance	$\theta_{(J-A)}$		_	450	_	°C/W

# **Luminous Intensity Bins**

The values have a tolerance of  $\pm 20\%$ .

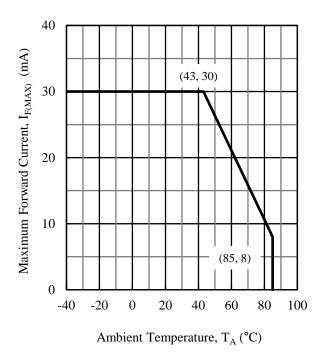
Bin Number	Luminous Intensity Range	Unit
С	36 to 47	mcd
D	47 to 63	mcd

## **Wavelength Bins**

The values have a tolerance of  $\pm 2$  nm.

Bin Number	Wavelength Range	Unit
В	462.5 to 465.0	nm
G1	465.0 to 467.5	nm
G2	467.5 to 470.0	nm

### **Derating Curves**



 $Figure \ 1. \quad I_{F(MAX)} \ vs. \ T_A$ 

### **Characteristic Curves**

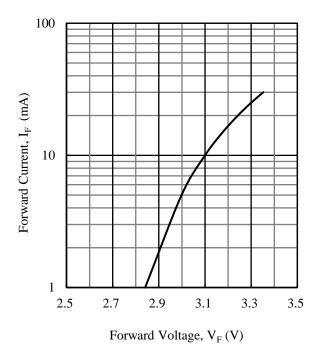


Figure 2. I<sub>F</sub> vs. V<sub>F</sub>

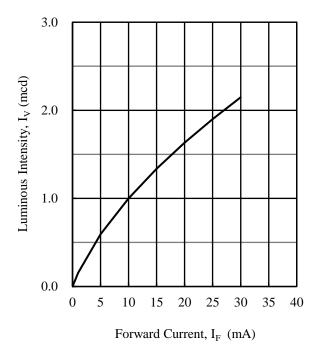
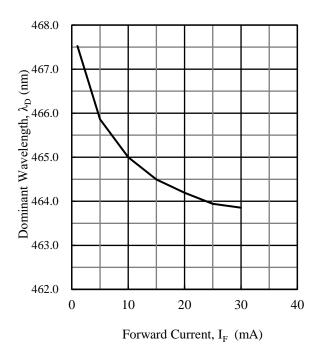
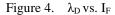


Figure 3. I<sub>V</sub> vs. I<sub>F</sub>





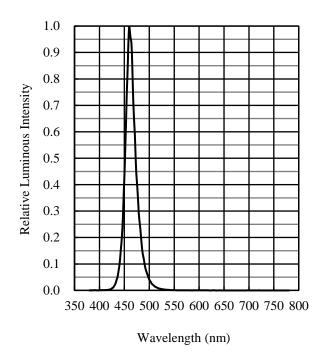


Figure 5. Spectrum

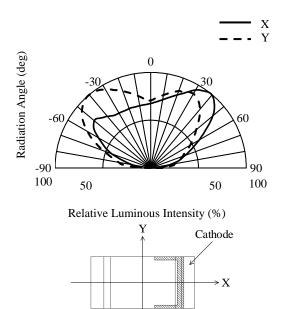
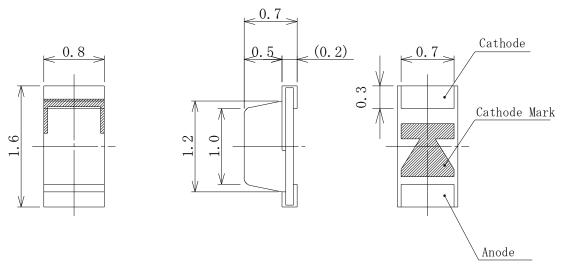


Figure 6. Directivity

### **Physical Dimensions**

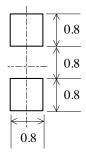
• Surface Mount  $(1.6 \times 0.8 \times 0.7 \text{ mm})$ 



### **NOTES:**

- Dimensions in millimeters
- RoHS compliant
- MSL 3 (Moisture Sensitivity Level 3)

# • Land Pattern Example



Unit: mm

#### SECG1E07C-SD

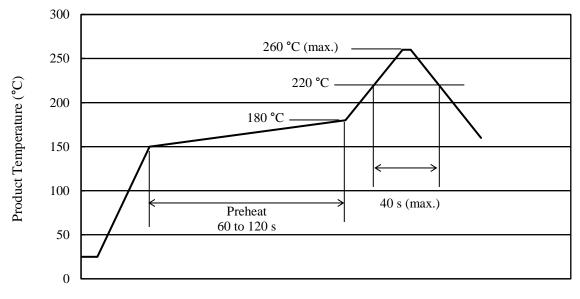
### **Soldering Conditions**

When soldering the products, it is required to minimize the working time within the following limits:

Preheat: 150 to 180  $^{\circ}$ C / 60 to 120 s

Solder heating:  $220 \, ^{\circ}\text{C} \, / \, 40 \, \text{s} \, (260 \, ^{\circ}\text{C} \, \text{peak}, 2 \, \text{times})$  - Soldering iron:  $350 \, \pm 10 \, ^{\circ}\text{C} \, / \, 3 \, \text{s}, 1 \, \text{time}$ 

#### • Reference Reflow Profile



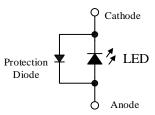
Time (s)

#### **Precautions for Use**

#### • Measures for Electrostatic Discharge (ESD)

Generally, InGaN-based elements such as blue LEDs are very sensitive to ESD. For enhanced ESD withstand capability, this product is designed to include a surge protection diode as shown in the figure below. Therefore, the following ESD withstand capabilities are ensured:  $\geq$ 200 V on machine model (C = 200 pF, R = 0  $\Omega$ ), and  $\geq$ 2000 V on human body model (C = 100 pF, R = 1.5 k $\Omega$ ). Note that, however, all the values mentioned above are not guaranteed.

When using the product, care should be taken not to apply a voltage in the opposite direction of the LED. If a voltage is applied in the opposite direction of the LED, the surge protection diode becomes conductive, and then an unintended current may flow through the set.



#### • Other

- After soldering the product, care should be taken not to apply mechanical stress or excessive vibration until it cools to room temperature.
- Do not cool the product rapidly.
- When mounting the product on a board, mounting position and orientation should be taken into account so that any stress due to board warpage is not applied to the product.
- Do not touch the encapsulating resin of the product with sharp objects such as a tweezer or fingernails. Also, do not use the product again after removal.
- Do not touch the product after mounting it on a board.
- The product emits a high-power light. Therefore, care should be taken not to look at the light emission directly for a long time because it may hurt your eyes.
- Use the product at rated current (sorting current) as much as possible. When the product is used at a current lower than the rated current (sorting current), a variation in forward voltage or luminous intensity may increase.

  Therefore, care should be taken for such variation when you use the product at low current.

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